#### HIGH FREQUENCY SI MOSFET RELAY ▲ 46 SERIES



# **46 SERIES**

# HIGH FREQUENCY A SI MOSFET RELAY

SILICON Si MOSFET RELAY ▲ DIP and SMD type Low output capacitance ▲ Switches AC or DC load One channel and two channel packages available Input TTL / CMOS compatible Moisture Sensitivity Level ▲ MSL 3 UL 1577 approved ▲ File no E344988

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# **SPECIFICATION**

Item		Characteristics	
Contact Form		1 Form A / 2 Form A ▲ Normally open switch	
Load Voltage	VL	80V	
Operation LED Current	I <sub>F ON</sub>	3mA	
Load Current	I <sub>L</sub>	80mA	
On-Resistance	R <sub>ON</sub>	35Ω	
Output Capacitance	C <sub>OUT</sub>	3pF	
Low Off-State Leakage Current	I <sub>LEAK</sub>	1nA at 80V <sub>DC</sub>	

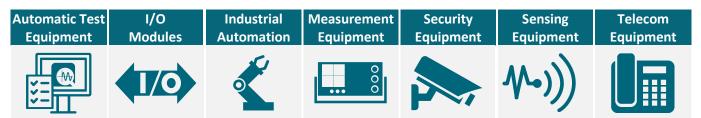
RoHS

REACH

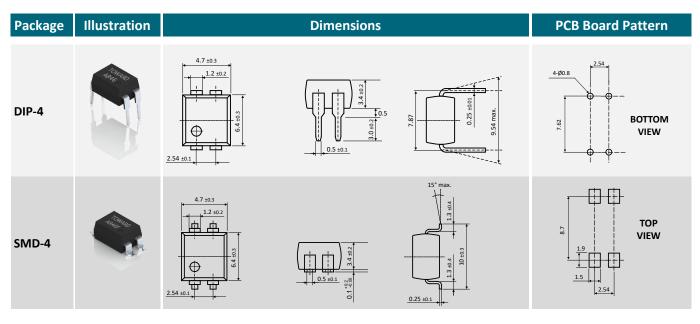
HALOGEN

FREE

### **APPLICATIONS**



#### DIMENSIONS



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## DIMENSIONS

Package	Illustration		Dimensions	PCB Board Pattern
DIP-6	TONNESS OF	8.8 ±0.3 1.2 ±0.2 1.2 ±0.2 1.2 ±0.2 1.2 ±0.2 1.2 ±0.2 1.2 ±0.2 1.2 ±0.2 1.2 ±0.2 1.2 ±0.2 1.2 ±0.2	0.5 ±0.1	
SMD-6	TOWNED AND A	8.8 ±0.3	15' max.	TOP VIEW
DIP-8	TO HERE	9.8 ±0.3 1.2 ±0.2 1.2 ±0.2 0.54 ±0.1 7.62	0.5 ±0.1	
SMD-8	TO HERE	9.8 ±0.3	15* max. 15* ma	
SOP-4			15° max. 10° ma	
SOP-8		4.3 ±0.3		C C C C C C C C C C C C C C C C C C C



# ABSOLUTE MAXIMUM RATINGS **A** AMBIENT TEMPERATURE T<sub>A</sub> = 25°C

	Item	Condition	Symbol		_	Value	_	_	Unit
	Outline package			SOP-4	SOP-8	DIP-4 SMD-4	DIP-8 SMD-8	DIP-6 SMD-6	
Туре	Part number			AB46S	AC46S	AB46(F)	AC46(F)	AA46(F)	
	Output channels			1	2	1	2	1	Channels
	Continuous LED Current		IF			50			mA
lanut	Peak LED Current	100 Hz, Duty 1%	IFP			500			mA
Input	LED Reverse Voltage		VR			5			V
	Input Power Dissipation		PIN			75			mV
	Load Voltage		VL		80 (/	AC peak o	r DC)		V
Output	Load Current		IL.			80			mA
Output	Peak Load Current	1 ms, 1 shot	IPEAK			100			mA
	Output Power Dissipation		Роит	300	450	300	450	300	mW
	Total Power Dissipation		PT	350	500	350	500	350	mW
	I/O Breakdown Voltage		V <sub>I/O</sub>	1500	1500	3750	3750	3750	V <sub>RMS</sub>
Relay	I/O Breakdown Voltage (Suffix-H)		Vı/o	3750	3750	5000	5000	5000	Vrms
	Operating Temperature Range		TOPR			-40 to +85	5		°C
	Storage Temperature Range		Tstg		-	40 to +10	0		°C

# **ELECTRICAL CHARACTERISTICS** A AMBIENT TEMPERATURE T<sub>A</sub> = 25°C

	Item	Condition	Symbol	Min.	Тур.	Max.	Unit
	LED Forward Voltage	I <sub>F</sub> = 10mA	VF	1	1.17	1.3	V
Input	Operation LED Current		I <sub>F ON</sub>		0.8	3	mA
	Recovery LED Voltage		V <sub>F OFF</sub>	0.5	1		V
Output	On-Resistance Drain to Drain (tested within 1 sec.)	I <sub>F</sub> =5mA, I∟=Rating	Ron		35	50	Ω
Output	Off-State Leakage Current	V <sub>L</sub> = 80V	I <sub>LEAK</sub>			1	nA
	Output Capacitance	V∟=0V, f=1MHz	COUT		3		рF
	Turn-On Time (for SOP type)	I <sub>F</sub> =5mA, I <sub>L</sub> =Rating	ton		0.02	0.2	ms
Trans-	Turn-Off Time (for SOP type)	I <sub>F</sub> =5mA, I <sub>L</sub> =Rating	toff		0.08	0.3	ms
mission	Turn-On Time (for DIP/SMD type)	$I_F$ =10mA, $I_L$ =Rating	t <sub>on</sub>		0.015	0.2	ms
	Turn-Off Time (for DIP/SMD type)	$I_F$ =10mA, $I_L$ =Rating	t <sub>OFF</sub>		0.08	0.3	ms
Constant	I/O Insulation Resistance		Rı/o	10 <sup>9</sup>			Ω
Coupled	I/O Capacitance	f=1MHz	Cı/o		1.3		pF



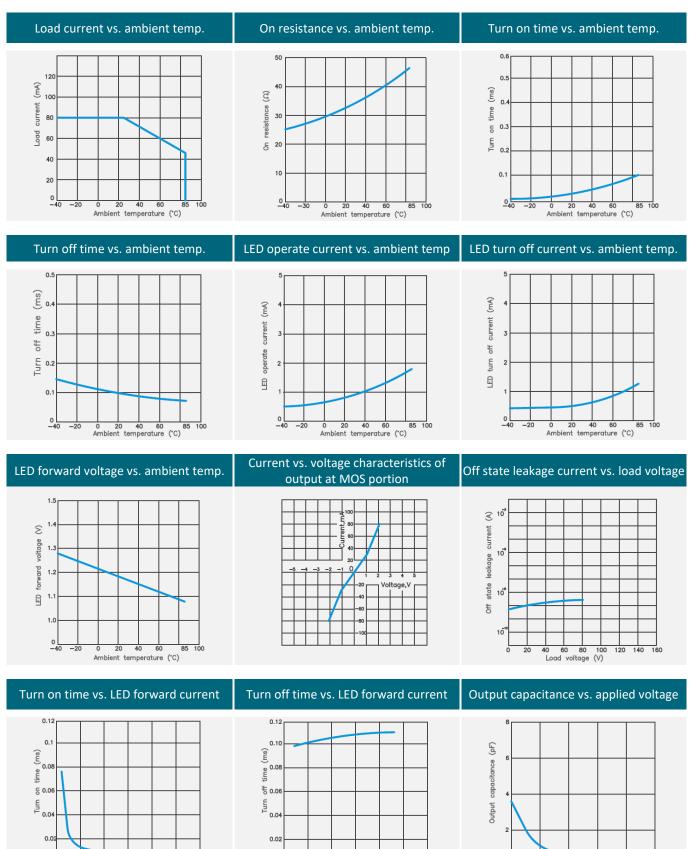
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10 20 30 Applied voltage (V)

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TOWARD RELAYS

## **REFERENCE DATA**



LED forward current (mA)

20 30

40

50

010

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LED forward current (mA)

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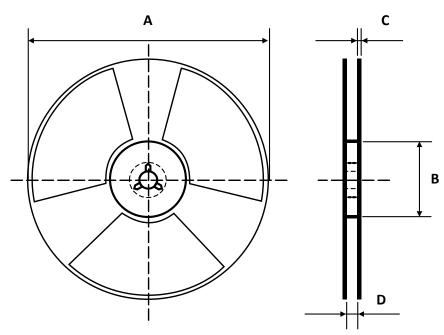


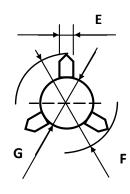
#### **PIN DESCRIPTION AND PART NUMBER**

Circuit Diagram	Pin Description	Part No.	Package	Packing
	1 Cathode (-) • LED	AB46S	SOP-4	Tube (100pcs)
	2 Drain • MOSFET	AB46S-R1	SOP-4	Reel (1000pcs)
	1 Cathode (-) • LED	AA46	DIP-6	Tube (50pcs)
	2 NC	AA46F	SMD-6	Tube (50pcs)
	3 Drain • MOSFET	AA46F-R1	SMD-6	Reel (1000pcs)
	1. Cathode (-) • LED	AC46S	SOP-8	Tube (50pcs)



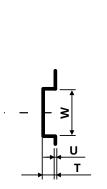
#### **REEL DIMENSIONS** All dimensions in mm

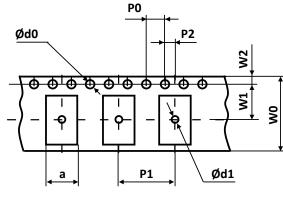




Size	А	В	С	D	E	F	G
SOP-4	330	100	2	13	2	13	21
SOP-8	330	100	2	17	2	13	21
SMD-4	380	80	2.2	17	2	13	21
SMD-6	380	80	2.2	17	2	13	21
SMD-8	380	80	2.2	17	2	13	21

#### **TAPE DIMENSIONS** All dimensions in mm





Feed Direction

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Size	w	U	т	а	Ød0	Ød1	P0	P1	P2	W0	W1	W2
SOP-4	4.6	0.3	2.3	7.2	1.5	1.5	4	12	2	12	7.5	1.75
SOP-8	10.4	0.3	2.3	7.5	1.5	1.5	4	12	2	16	7.5	1.75
SMD-4	5.3	0.3	4	10.6	1.5	1.5	4	16	2	16	7.5	1.75
SMD-6	9.15	0.3	4.45	10.4	1.5	1.5	4	16	2	16	11.5	1.75
SMD-8	9.9	0.3	4	10.6	1.5	1.5	4	16	2	16	7.5	1.75

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# **PACKING QUANTITIES**

Tape and Reel Packing	PCS/Reel
SMD-4	1000
SMD-6	1000
SMD-8	1000
SOP-4	1000
SOP-8	1000

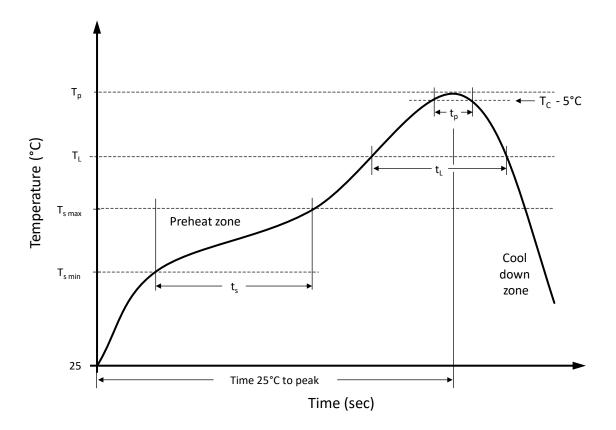
Tube Packing	PCS/Tube	Tubes/Box	Units/Box
DIP-4	90	30	2 700
DIP-6	50	30	1500
DIP-8	45	30	1350
SMD-4	90	30	2 700
SMD-6	50	30	1500
SMD-8	45	30	1350
SOP-4	100	30	3000
SOP-8	50	30	1500

# STORAGE AND HANDLING CONDITIONS

ESD level	Floor life	Conditions	MSL
HBM class 2	Unlimited	T <sub>A</sub> < 30°C, RH < 85%	1



# **RECOMMENDED REFLOW SOLDERING PROFILE A SMD PACKAGE**



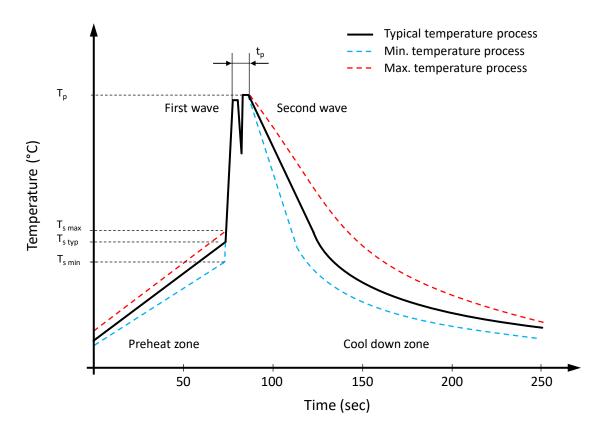
## **Recommended reflow soldering conditions** ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	Ts min	100 °C	150 °C
Preheat temperature max.	$T_{s max}$	150 °C	200 °C
Preheat time ts from Ts min to Ts max	ts	120 seconds	120 seconds
Ramp-up rate (T <sub>L</sub> to T <sub>p</sub> )		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	ΤL	183 °C	217 °C
Time $t_L$ maintained above $T_L$	tL	150 seconds max.	60 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	tp	20 seconds max.	30 seconds max.
Ramp-down rate (T <sub>L</sub> to T <sub>p</sub> )		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes

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## **RECOMMENDED WAVE SOLDERING PROFILE ▲ THT PACKAGE**



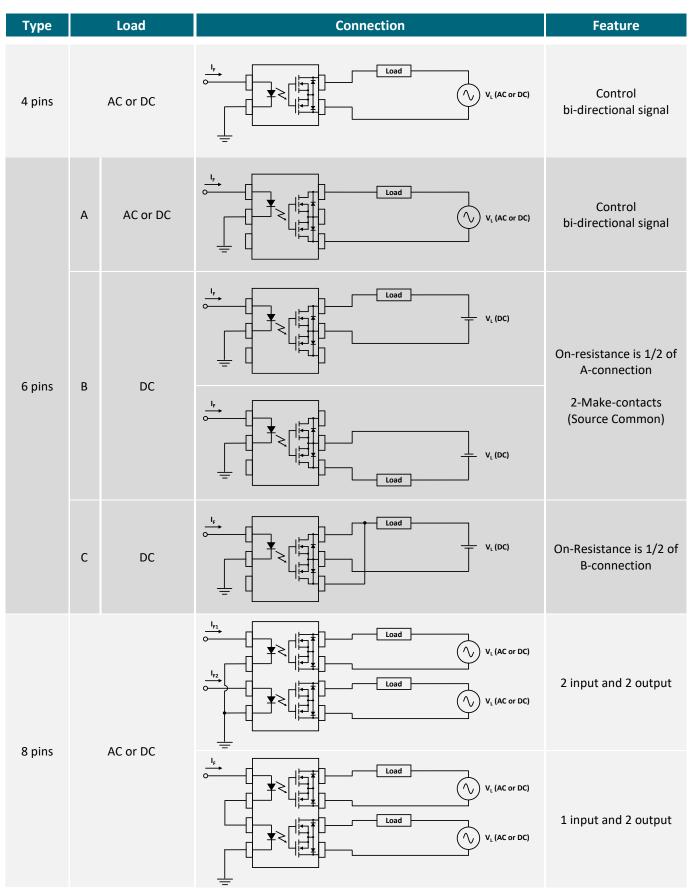
#### Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value 🔺 Pb-free Assembly
Preheat temperature min.	T <sub>s min</sub>	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{smax}$	130 °C	130 °C
Preheat time $t_s$ from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	tp	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



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## LOAD CONNECTING METHOD



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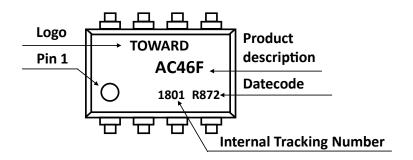
# **PRODUCT CODE**

Example: AC46F series  $\blacktriangle$  2 Form A  $\blacklozenge$  80V  $\blacklozenge$  SMD-8  $\bigstar$  Tape & Reel

AC		46		-		F		R1	
Package		Series		Special Suffix		Туре		Packing	
AA AB	6 Pin ▲ 1 Form A 4 Pin ▲ 1 Form A	46	80V	Blank	Standard	Blank F	DIP SMD	Blank	Tube
AC	8 Pin ▲ 2 Form A	40	000	н	High Insulation	S	SOP	R1	Reel

## **PRODUCT MARKING**

Example: AC46F series  $\blacktriangle$  2 Form A  $\blacklozenge$  80V  $\blacklozenge$  SMD-8  $\bigstar$  Tape & Reel



# DATE CODE

Example: R872

	R	3	3	-	7		2
Material Characteristics		Year		Month		Week of the Month	
R H	RoHS compliant Halogen free	8 9 A B C  G	2018 2019 2020 2021 2022  2026	1 2 3 4 5  12	Jan Feb Mar Apr May  Dec	1 2 3 4	1 <sup>st</sup> 2 <sup>nd</sup> 3 <sup>rd</sup> 4 <sup>th</sup>



## **RELIABILITY TESTS A STANDARD**

#### Standard: JESD22-A

No.	Test	Test	Test	Test Limits	
1	Moisture Sensitivity Level Test	Specification Bake condition: Temperature: 125°C; Duration 24 hours Soak condition: Temperature: 30°C; Humidity: 60% RH Duration 192 hours Reflow condition: Peak temperature: 260°C Duration: 3 cycles	Standard JESD22-A113H	No abnormal phenome- non was found. Functional test passed.	
2	High Temperature Storage Test	Temperature: 150°C Duration: 500 hours	JESD22-A103E	No abnormal phenome- non was found. Functional test passed.	
3	Temperature Cycling Test	Temperature range: -55°C to +125°C -55°C for 30 minutes +125°C for 30 minutes Duration: 100 cycles with 1 cycle = 70 minutes	JESD22-A104E	No abnormal phenome- non was found. Functional test passed.	
4	Low Temperature Storage Test	Temperature: -40°C Duration: 500 hours	JESD22-A119E	No abnormal phenome- non was found. Functional test passed.	
5	Temperature & Humidity Storage Test	Temperature: 85°C Humidity: 85% RH Duration: 500 hours	JESD22-A101D	No abnormal phenome- non was found. Functional test passed.	
6	Highly Accelerated Temperature and Humidity Stress Test	Temperature: 130°C Humidity: 85% RH Duration: 96 hours	JESD22-A-118B	No abnormal phenome- non was found. Functional test passed.	

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### **REVISION TABLE**

Revision	Date	Status	Notes
001	01/10/2021	Initial release	Initial publication

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